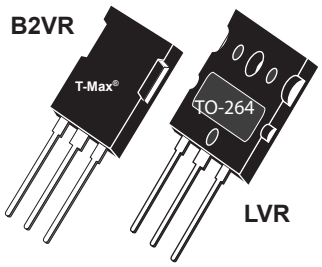
APT20M18B2VR
A20M18LVR

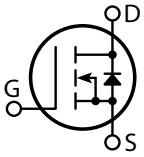
200V 100A 0.018Ω

POWER MOS V® MOSFET



Power MOS V® is a new generation of high voltage N-Channel enhancement mode power MOSFETs. This new technology minimizes the JFET effect, increases packing density and reduces the on-resistance. Power MOS V® also achieves faster switching speeds through optimized gate layout.

- TO-264 MAX Package
- Avalanche Energy Rated
- Faster Switching
- Lower Leakage



MAXIMUM RATINGS — All Ratings: T_C = 25°C unless otherwise specified.

Symbol	Parameter	APT20M18B2VR_LVR	UNIT
V_{DSS}	Drain-Source Voltage	200	Volts
I_D	Continuous Drain Current ⑥ @ T_C = 25°C	100	Amps
I_{DM}	Pulsed Drain Current ①	400	
V_{GS}	Gate-Source Voltage Continuous	±30	Volts
V_{GSM}	Gate-Source Voltage Transient	±40	
P_D	Total Power Dissipation @ T_C = 25°C	625	Watts
	Linear Derating Factor	5.00	W/°C
T_J,T_{STG}	Operating and Storage Junction Temperature Range	-55 to 150	°C
T_L	Lead Temperature: 0.063" from Case for 10 Sec.	300	
I_{AR}	Avalanche Current ① (Repetitive and Non-Repetitive)	100	Amps
E_{AR}	Repetitive Avalanche Energy ①	50	mJ
E_{AS}	Single Pulse Avalanche Energy ④	3000	

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
BV_{DSS}	Drain-Source Breakdown Voltage (V_{GS} = 0V, I_D = 250µA)	200			Volts
$R_{DS(on)}$	Drain-Source On-State Resistance ② (V_{GS} = 15V, I_D = 50A)			0.018	Ohms
I_{DSS}	Zero Gate Voltage Drain Current (V_{DS} = 200V, V_{GS} = 0V)			25	µA
	Zero Gate Voltage Drain Current (V_{DS} = 160V, V_{GS} = 0V, T_C = 125°C)			250	
I_{GSS}	Gate-Source Leakage Current (V_{GS} = ±30V, V_{DS} = 0V)			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage (V_{DS} = V_{GS}, I_D = 2.5mA)	2		4	Volts

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

DYNAMIC CHARACTERISTICS

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C_{iss}	Input Capacitance	V_{GS} = 0V V_{DS} = 25V f = 1 MHz		9880		pF
C_{oss}	Output Capacitance			2320		
C_{rss}	Reverse Transfer Capacitance			700		
Q_g	Total Gate Charge ③	V_{GS} = 10V V_{DD} = 150V I_D = 100A @ 25°C		330		nC
Q_{gs}	Gate-Source Charge			55		
Q_{gd}	Gate-Drain ("Miller") Charge			145		
$t_{d(on)}$	Turn-on Delay Time	V_{GS} = 15V V_{DD} = 150V I_D = 100A @ 25°C R_G = 0.6Ω		18		ns
t_r	Rise Time			27		
$t_{d(off)}$	Turn-off Delay Time			55		
t_f	Fall Time			6		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
I_S	Continuous Source Current (Body Diode)			100	Amps
I_{SM}	Pulsed Source Current ① (Body Diode)			400	
V_{SD}	Diode Forward Voltage ② (V_{GS} = 0V, I_S = -49A)			1.3	Volts
t_{rr}	Reverse Recovery Time (I_S = -49A, dI_S/dt = 100A/μs)		360		ns
Q_{rr}	Reverse Recovery Charge (I_S = -49A, dI_S/dt = 100A/μs)		6.7		μC
$^{dv}/_{dt}$	Peak Diode Recovery $^{dv}/_{dt}$ ⑤			5	V/ns

THERMAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to Case			0.20	°C/W
$R_{\theta JA}$	Junction to Ambient			40	

① Repetitive Rating: Pulse width limited by maximum junction temperature

② Pulse Test: Pulse width < 380 μs, Duty Cycle < 2%

③ See MIL-STD-750 Method 3471

④ Starting T_j = +25°C, L = 600μH, R_G = 25Ω, Peak I_L = 100A

⑤ $^{dv}/_{dt}$ numbers reflect the limitations of the test circuit rather than the device itself. $I_S \le -I_D$100A $^{di}/_{dt} \le$ 200A/μs $V_R \le$200V $T_J \le$150°C

⑥ The maximum current is limited by lead temperature.

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

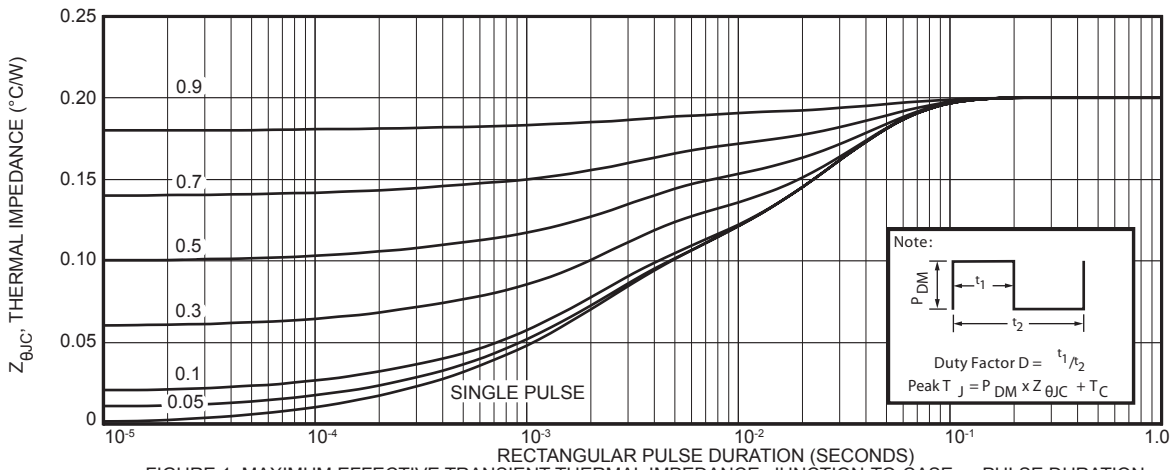


FIGURE 1, MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs PULSE DURATION

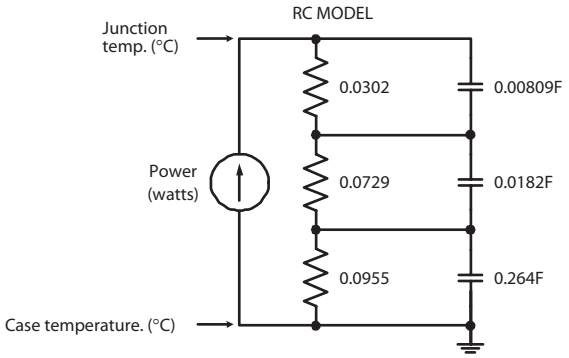


FIGURE 2, TRANSIENT THERMAL IMPEDANCE MODEL

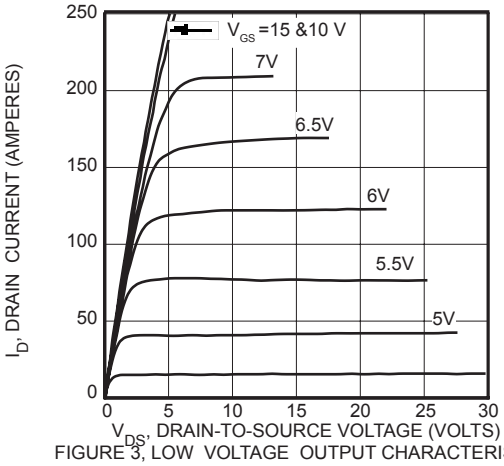


FIGURE 3, LOW VOLTAGE OUTPUT CHARACTERISTICS

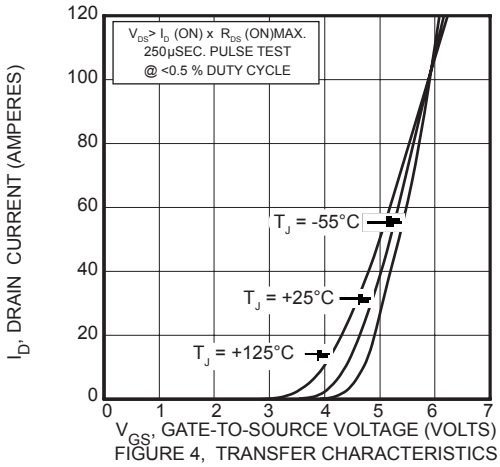


FIGURE 4, TRANSFER CHARACTERISTICS

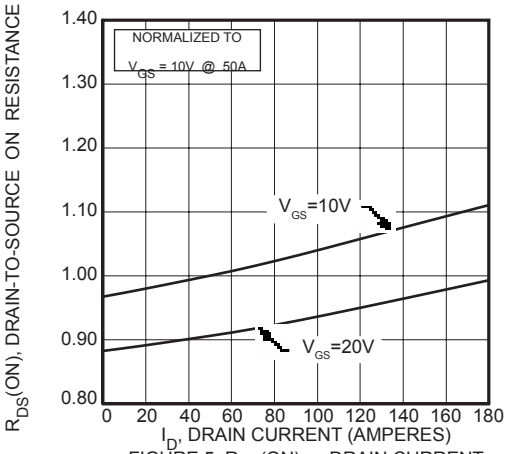


FIGURE 5, R_{DS}(ON) vs DRAIN CURRENT

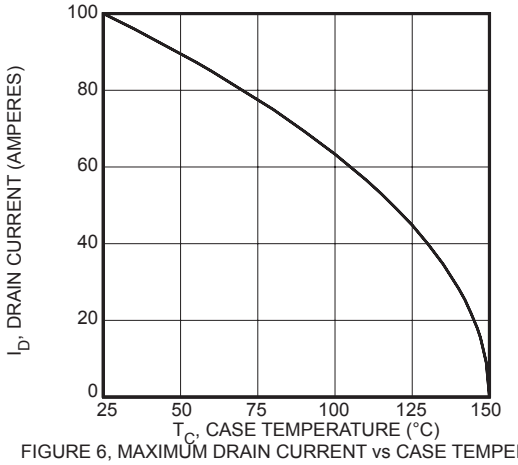


FIGURE 6, MAXIMUM DRAIN CURRENT vs CASE TEMPERATURE

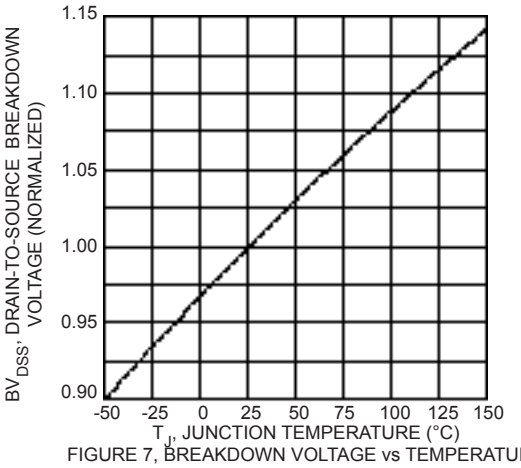


FIGURE 7, BREAKDOWN VOLTAGE vs TEMPERATURE

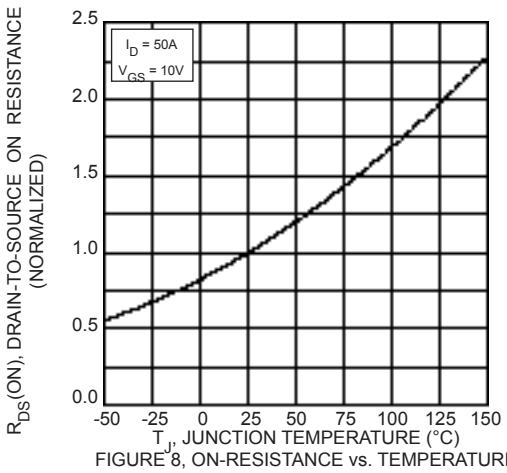


FIGURE 8, ON-RESISTANCE vs. TEMPERATURE

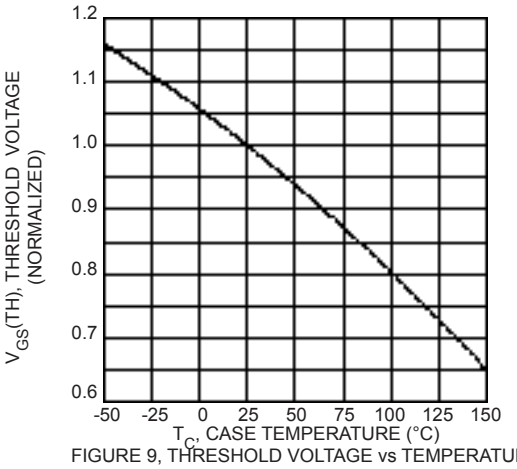


FIGURE 9, THRESHOLD VOLTAGE vs TEMPERATURE

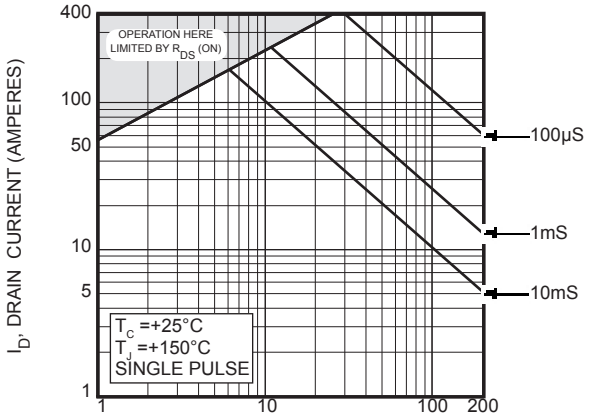


FIGURE 10, MAXIMUM SAFE OPERATING AREA

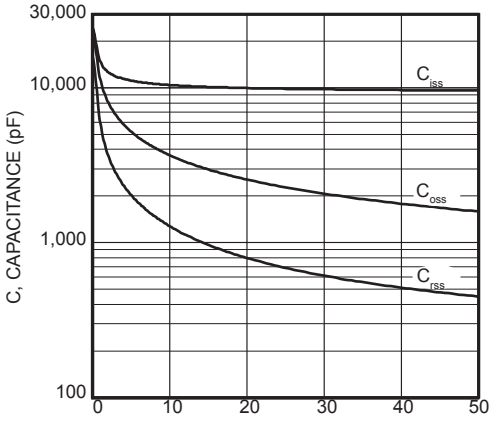


FIGURE 11, CAPACITANCE vs DRAIN-TO-SOURCE VOLTAGE

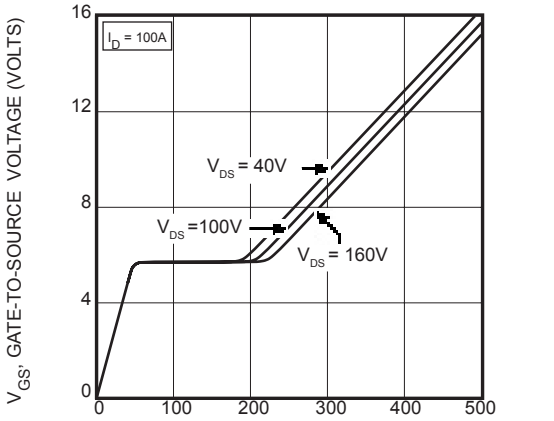


FIGURE 12, GATE CHARGE vs GATE-TO-SOURCE VOLTAGE

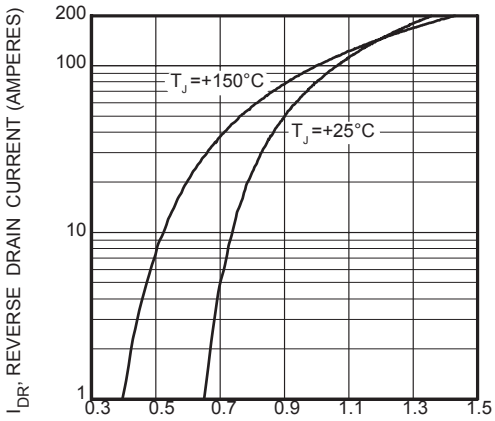
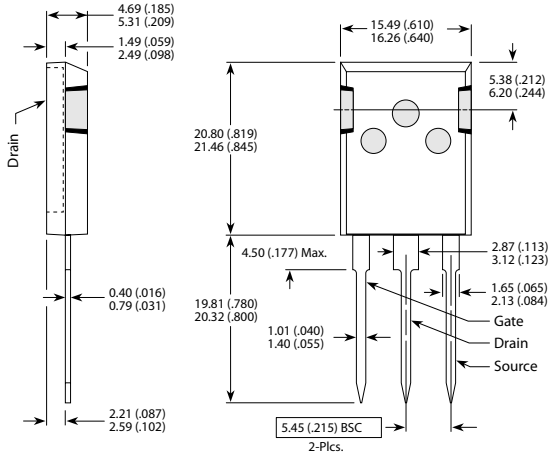


FIGURE 13, SOURCE-DRAIN DIODE FORWARD VOLTAGE

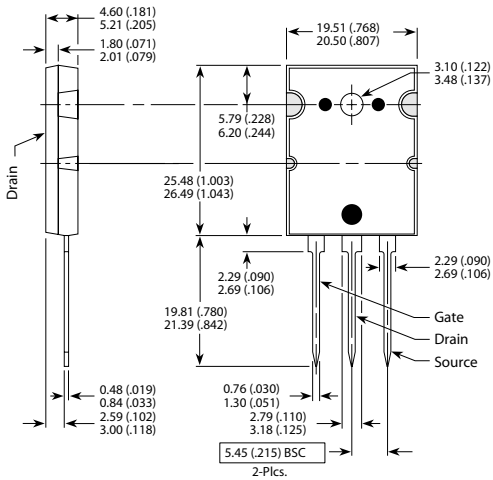
T-MAX™ (B2) Package Outline (B2VR)



These dimensions are equal to the TO-247 without the mounting hole.

Dimensions in Millimeters and (Inches)

TO-264 (L) Package Outline (LVR)



Dimensions in Millimeters and (Inches)

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